



# Product Change Notification

**Change Notification #:** 116319 - 00  
**Change Title:** Intel® Server Board S2600STB, OEM 10 Pack,  
Intel® Server Board S2600STB,  
Intel® Server Board S2600STQ, OEM 10 Pack,  
Intel® Server Board S2600STQ  
PCN 116319-00, Product Design,  
Update BIOS/BMC/ME/FRUSDR  
Firmware  
**Date of Publication:** June 21, 2018

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material: *</b>	July 8, 2018
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Boards listed in the "Products Affected" table below:

1. Update BIOS revision from R00.01.0009 to R00.01.5013
2. Update the Manageability Engine (ME) firmware revision from 04.00.04.288 to 04.00.04.294
3. Update the Baseboard Management Controller (BMC) firmware revision from 1.29.7d703f59 to 1.43.627d127a
4. Update the FRUSDR revision from 1.24 to 1.28.

Intel Server Boards with factory firmware will display the following message on each boot until the BIOS is updated:

*"WARNING: This Server is running factory firmware. A software update is required. As part of your system integration process, please load the latest system update package (SUP) to enable the latest security, quality and performance."*

## Customer Impact of Change and Recommended Action:

The primary value of this factory BIOS is that it allows the customer to perform a single BIOS programming (upgrade or downgrade) without the requirement of moving the BIOS Recovery physical jumper. Once the first programming is done, any subsequent attempts to downgrade to a previous BIOS version will require moving the BIOS Recovery physical jumper.

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <https://www.intel.com/support/>

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
S2600STB	957180	J18286-009	J17012-502	J18286-010	J17012-503
S2600STQ	957318	J22290-011	J17014-503	J22290-012	J17014-504
BBS2600STQ	959727	J65788-004	J17014-503	J65788-005	J17014-504
BBS2600STB	959820	J65786-003	J17012-502	J65786-004	J17012-503

## PCN Revision History:

**Date of Revision:**

June 21, 2018

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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